PMLL4148L; **PMLL4448**

High-speed switching diodes Rev. 8 — 1 February 2011

Product data sheet

Product profile 1.

1.1 General description

Single high-speed switching diodes, fabricated in planar technology, and encapsulated in small hermetically sealed glass SOD80C Surface-Mounted Device (SMD) packages.

Table 1. **Product overview**

Type number	Package	Configuration
PMLL4148L	SOD80C	single
PMLL4448		

1.2 Features and benefits

■ High switching speed: $t_{rr} \le 4$ ns

Reverse voltage: V_R ≤ 75 V

Repetitive peak reverse voltage: V_{RRM} ≤ 100 V Repetitive peak forward current: I_{FRM} ≤ 450 mA Small hermetically sealed glass SMD package

1.3 Applications

- High-speed switching
- Reverse polarity protection

1.4 Quick reference data

Quick reference data Table 2.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _F	forward current		<u>[1]</u> -	-	200	mA
I _{FRM}	repetitive peak forward current		-	-	450	mA
V_R	reverse voltage		-	-	75	V
V _F	forward voltage					
	PMLL4148L	$I_F = 50 \text{ mA}$	-	-	1	V
	PMLL4448	$I_F = 5 \text{ mA}$	620	-	720	mV
		$I_F = 100 \text{ mA}$	-	-	1	V
t _{rr}	reverse recovery time		[2] _	-	4	ns

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard

^[2] When switched from $I_F = 10$ mA to $I_R = 60$ mA; $R_L = 100$ Ω ; measured at $I_R = 1$ mA.



2. Pinning information

Table 3. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	1.4
2	anode	k	**
			sym006

^[1] The marking band indicates the cathode.

3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
PMLL4148L	-	hermetically sealed glass surface-mounted package;	SOD80C
PMLL4448		2 connectors	

4. Marking

Table 5. Marking codes

Type number	Marking code
PMLL4148L	marking band
PMLL4448	marking band

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage		-	100	V
V_R	reverse voltage		-	75	V
I _F	forward current		<u>[1]</u> -	200	mA
I _{FRM}	repetitive peak forward current		-	450	mA
I _{FSM}	non-repetitive peak forward	square wave	[2]		
	current	t _p = 1 μs	-	4	Α
		$t_p = 1 \text{ ms}$	-	1	Α
		$t_p = 1 s$	-	0.5	А

 Table 6.
 Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot}	total power dissipation	$T_{amb} = 25 ^{\circ}C$	<u>[1]</u> _	500	mW
Tj	junction temperature		-	200	°C
T _{amb}	ambient temperature		-65	+200	°C
T _{stg}	storage temperature		-65	+200	°C

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	350	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	300	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

7. Characteristics

Table 8. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{F}	forward voltage					
	PMLL4148L	$I_F = 50 \text{ mA}$	-	-	1	V
	PMLL4448	I _F = 5 mA	620	-	720	mV
		I _F = 100 mA	-	-	1	V
I _R	reverse current	V _R = 20 V	-	-	25	nA
		$V_R = 20 \text{ V}; T_j = 150 ^{\circ}\text{C}$	-	-	50	μΑ
I _R	reverse current					
	PMLL4448	$V_R = 20 \text{ V}; T_j = 100 ^{\circ}\text{C}$	-	-	3	μΑ
C_d	diode capacitance	$V_R = 0 V$; $f = 1 MHz$	-	-	4	pF
t _{rr}	reverse recovery time		[1] _	-	4	ns
V_{FR}	forward recovery voltage		[2] _	-	2.5	V

^[1] When switched from I_F = 10 mA to I_R = 60 mA; R_L = 100 $\Omega;$ measured at I_R = 1 mA.

^[2] $T_i = 25$ °C prior to surge.

^[2] When switched from I_F = 50 mA; t_r = 20 ns.

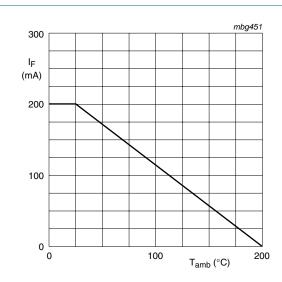
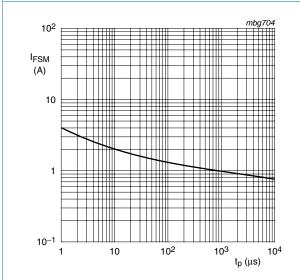


Fig 1. Forward current as a function of ambient temperature; derating curve

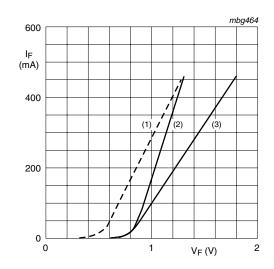
FR4 PCB, standard footprint



Based on square wave currents.

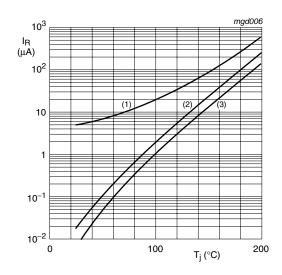
 $T_i = 25$ °C; prior to surge

Fig 3. Non-repetitive peak forward current as a function of pulse duration; maximum values



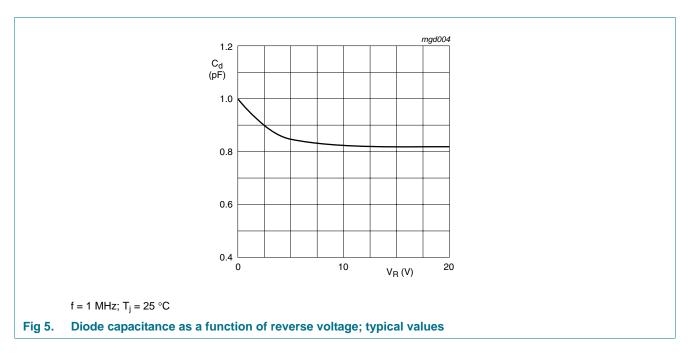
- (1) $T_j = 175$ °C; typical values
- (2) $T_i = 25$ °C; typical values
- (3) $T_i = 25 \,^{\circ}C$; maximum values

Fig 2. Forward current as a function of forward voltage

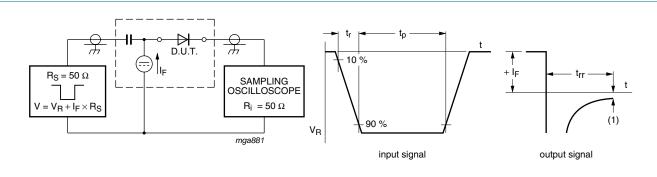


- (1) V_R = 75 V; maximum values
- (2) V_R = 75 V; typical values
- (3) $V_R = 20 \text{ V}$; typical values

Fig 4. Reverse current as a function of junction temperature



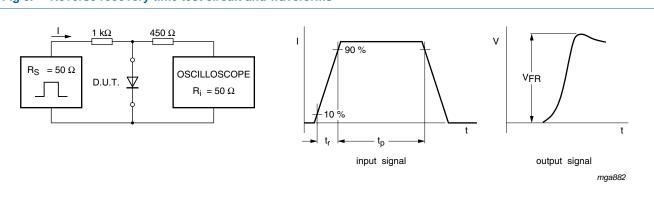
8. Test information



(1) $I_R = 1 \text{ mA}$

Input signal: reverse pulse rise time t_r = 0.6 ns; reverse voltage pulse duration t_p = 100 ns; duty cycle $\delta \le 0.05$ Oscilloscope: rise time t_r = 0.35 ns

Fig 6. Reverse recovery time test circuit and waveforms



Input signal: forward pulse rise time t_r = 20 ns; forward current pulse duration $t_p \ge 100$ ns; duty cycle $\delta \le 0.005$

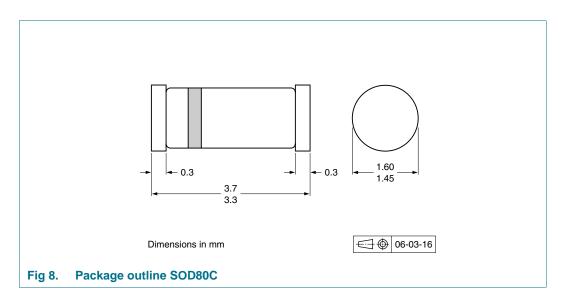
Fig 7. Forward recovery voltage test circuit and waveforms

PMLL4148L_PMLL4448

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9. Package outline



10. Packing information

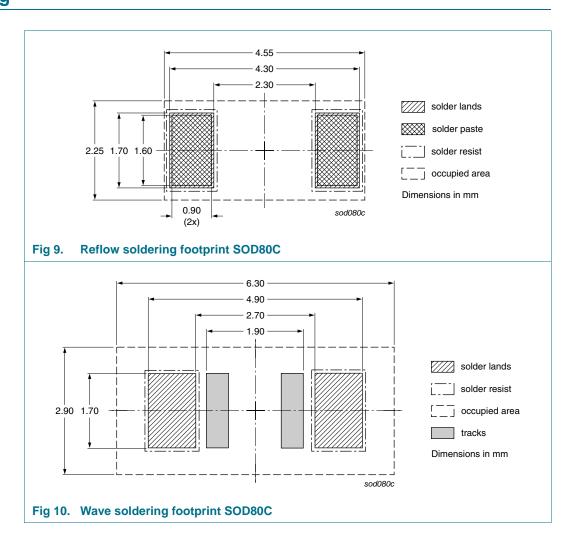
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	ype number Package Description		Packing o	Packing quantity		
			2500	10000		
PMLL4148L	SOD80C	4 mm pitch, 8 mm tape and reel	-115	-135		
PMLL4448						

^[1] For further information and the availability of packing methods, see Section 14.

11. Soldering



12. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMLL4148L_PMLL4448 v.8	20110201	Product data sheet	-	PMLL4148L_PMLL4448 v.7
Modifications:	 Section 4 "M 	arking": amended.		
	• Figure 8: rep	laced by minimized outline of	drawing.	
	Section 13 "I	<u>egal information</u> ": updated.		
PMLL4148L_PMLL4448 v.7	20070131	Product data sheet	-	PMLL4148L_PMLL4448 v.6
PMLL4148L_PMLL4448 v.6	20050404	Product data sheet	-	PMLL4148L_4448 v.5
PMLL4148L_4448 v.5	20020123	Product specification	-	PMLL4148L_4448 v.4
PMLL4148L_4448 v.4	20001115	Product specification	-	PMLL4148 v.3
PMLL4148 v.3	19990527	Product specification	-	PMLL4148 v.2
PMLL4148 v.2	19960918	Product specification	-	PMLL4148 v.1
PMLL4148 v.1	19960423	Product specification	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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High-speed switching diodes

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15. Contents

1	Product profile	1
1.1	General description	1
1.2	Features and benefits	1
1.3	Applications	1
1.4	Quick reference data	1
2	Pinning information	2
3	Ordering information	2
4	Marking	2
5	Limiting values	2
6	Thermal characteristics	3
7	Characteristics	3
8	Test information	5
9	Package outline	6
10	Packing information	6
11	Soldering	7
12	Revision history	8
13	Legal information	9
13.1	Data sheet status	Ĉ
13.2	Definitions	Ĉ
13.3	Disclaimers	
13.4	Trademarks1	C
14	Contact information 1	0
15	Contents	11

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